

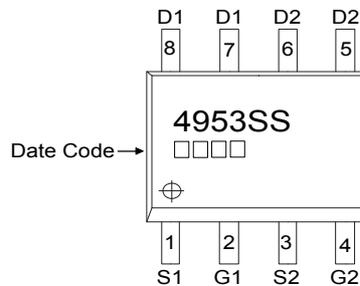
RoHS Compliant Product  
A suffix of "-C" specifies halogen & lead-free

**Description**

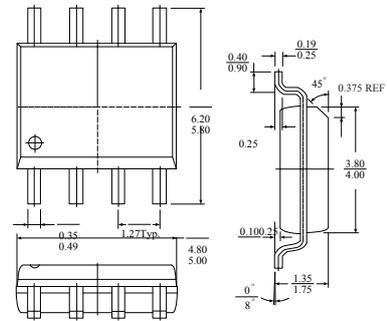
The SSG4953 provide the designer with the best Combination of fast switching, ruggedized device design, Ultra low on-resistance and cost-effectiveness. The SOP-8 is universally preferred for all commercial industrial surface mount application and suited for low voltage applications such as DC/DC converters.

**Features**

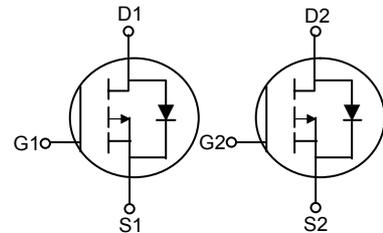
- \* Low on-resistance
- \* Simple drive requirement
- \* Fast switching Characteristic



**SOP-8**



Dimensions in millimeters



**Absolute Maximum Ratings**

Parameter	Symbol	Ratings	Unit
Drain-Source Voltage	V <sub>DS</sub>	-30	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Continuous Drain Current <sup>3</sup>	I <sub>D</sub> @T <sub>A</sub> =25°C	-5	A
Continuous Drain Current <sup>3</sup>	I <sub>D</sub> @T <sub>A</sub> =70°C	-4	A
Pulsed Drain Current <sup>1</sup>	I <sub>DM</sub>	-20	A
Total Power Dissipation	P <sub>D</sub> @T <sub>A</sub> =25°C	2	W
Linear Derating Factor		0.016	W/°C
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55~+150	°C

**Thermal Data**

Parameter	Symbol	Ratings	Unit
Thermal Resistance Junction-ambient <sup>3</sup> (Max)	R <sub>thj-a</sub>	62.5	°C/W

## Electrical Characteristics( T<sub>j</sub>=25°C Unless otherwise specified)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-30	-	-	V	V <sub>GS</sub> =0V, I <sub>D</sub> =-250uA
Breakdown Voltage Temp. Coefficient	ΔBV <sub>DSS</sub> /ΔT <sub>j</sub>	-	-0.1	-	V/°C	Reference to 25°C, I <sub>D</sub> =-1mA
Gate Threshold Voltage	V <sub>GS(th)</sub>	-1.0	-	-2.5	V	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250uA
Gate-Source Leakage Current	I <sub>GSS</sub>	-	-	±100	nA	V <sub>GS</sub> =±20V
Drain-Source Leakage Current (T <sub>j</sub> =25°C)	I <sub>DSS</sub>	-	-	-1	uA	V <sub>DS</sub> =-30V, V <sub>GS</sub> =0
Drain-Source Leakage Current (T <sub>j</sub> =70°C)		-	-	-25	uA	V <sub>DS</sub> =-24V, V <sub>GS</sub> =0
Static Drain-Source On-Resistance <sup>2</sup>	R <sub>DS(ON)</sub>	-	-	53	mΩ	V <sub>GS</sub> =-10V, I <sub>D</sub> =-5A
		-	-	90		V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-4A
Total Gate Charge <sup>2</sup>	Q <sub>g</sub>	-	11.7	-	nC	I <sub>D</sub> =-5A V <sub>DS</sub> =-15V V <sub>GS</sub> =-10V
Gate-Source Charge	Q <sub>gs</sub>	-	2.1	-		
Gate-Drain ("Miller") Charge	Q <sub>gd</sub>	-	2.9	-		
Turn-on Delay Time <sup>2</sup>	T <sub>d(ON)</sub>	-	9	-	nS	V <sub>DD</sub> =-15V I <sub>D</sub> =-1A V <sub>GS</sub> =-10V R <sub>G</sub> =6Ω R <sub>D</sub> =15Ω
Rise Time	T <sub>r</sub>	-	10	-		
Turn-off Delay Time	T <sub>d(OFF)</sub>	-	37	-		
Fall Time	T <sub>f</sub>	-	23	-		
Input Capacitance	C <sub>iss</sub>	-	582	-	pF	V <sub>GS</sub> =0V V <sub>DS</sub> =-15V f=1.0MHz
Output Capacitance	C <sub>oss</sub>	-	125	-		
Reverse Transfer Capacitance	C <sub>rss</sub>	-	86	-		
Forward Transconductance	G <sub>fs</sub>	-	5	-	S	V <sub>DS</sub> =-5V, I <sub>D</sub> =-5A

## Source-Drain Diode

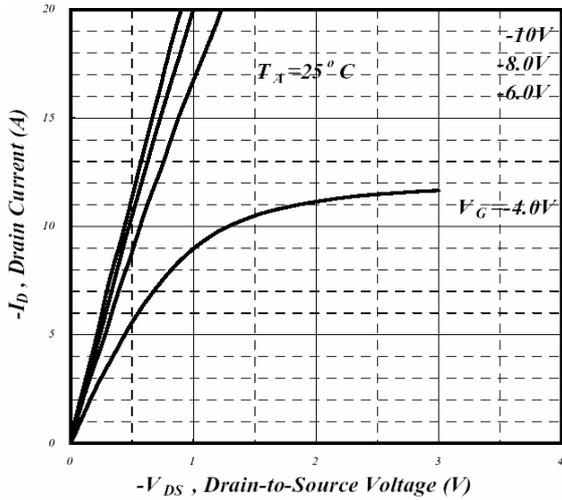
Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Forward On Voltage <sup>2</sup>	V <sub>DS</sub>	-	-	-1.2	V	I <sub>S</sub> =1.7A, V <sub>GS</sub> =0V.
Reverse Recovery Time <sup>2</sup>	T <sub>rr</sub>	-	24	-	nS	I <sub>S</sub> =-5A, V <sub>GS</sub> =0V di/dt=100A/uS
Reverse Recovery Charge	Q <sub>rr</sub>	-	19	-	nC	

Notes: 1.Pulse width limited by safe operating area.

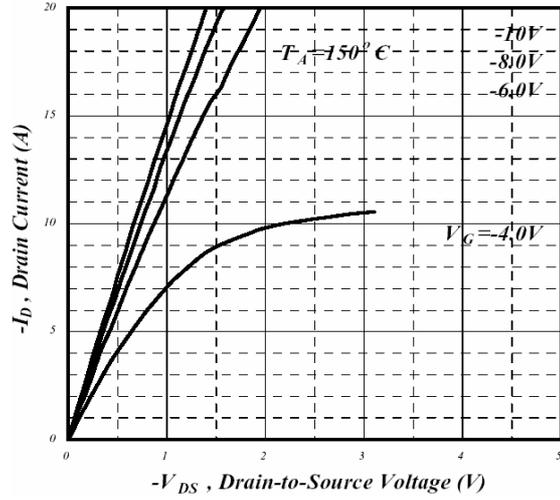
2.Pulse width ≤300us, dutycycle ≤2%.

3.Surface mounted on 1 in<sup>2</sup>copper pad of FR4 board; 135°C/W when mounted on min. copper pad.

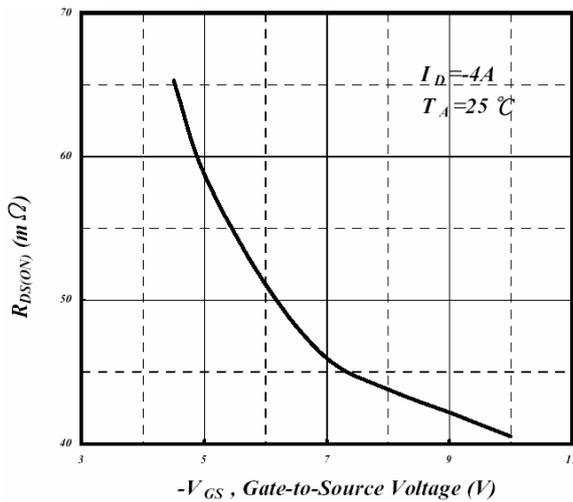
**Characteristics Curve**



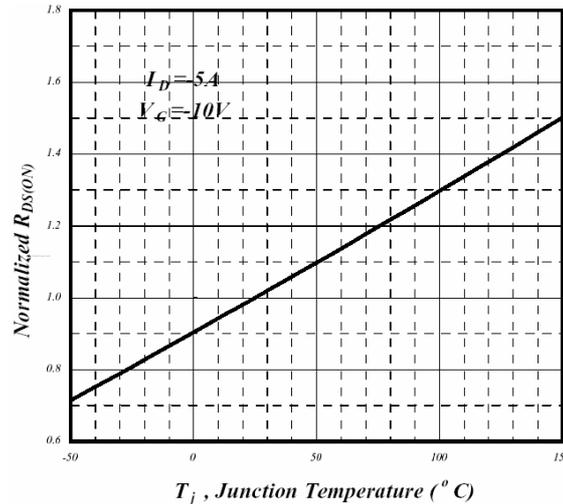
**Fig 1. Typical Output Characteristics**



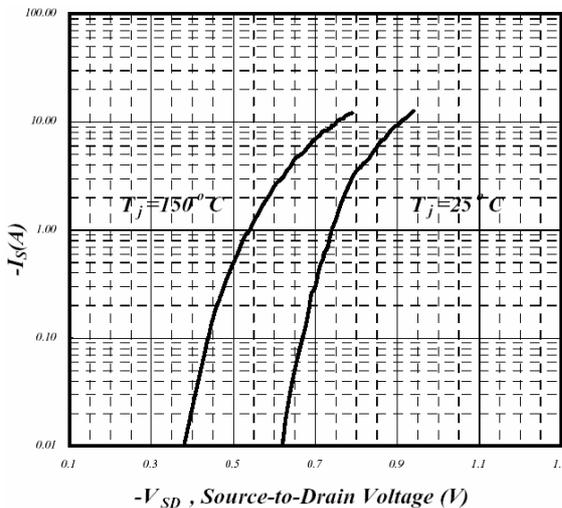
**Fig 2. Typical Output Characteristics**



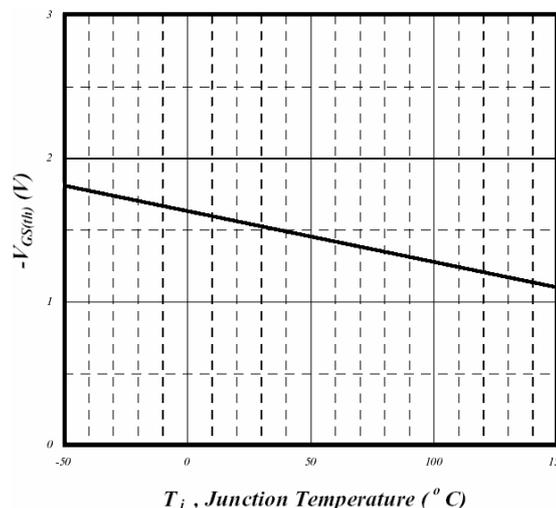
**Fig 3. On-Resistance v.s. Gate Voltage**



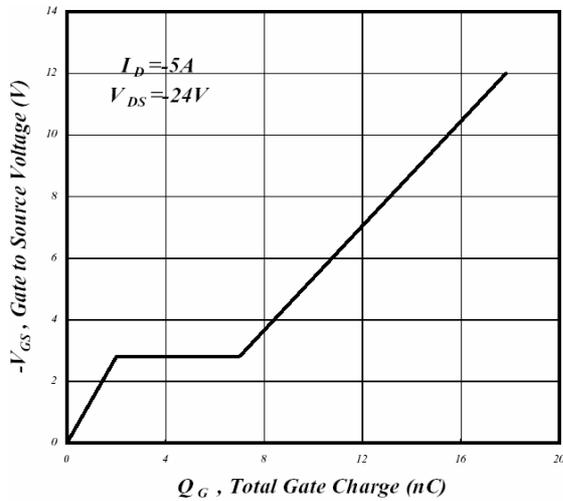
**Fig 4. Normalized On-Resistance v.s. Junction Temperature**



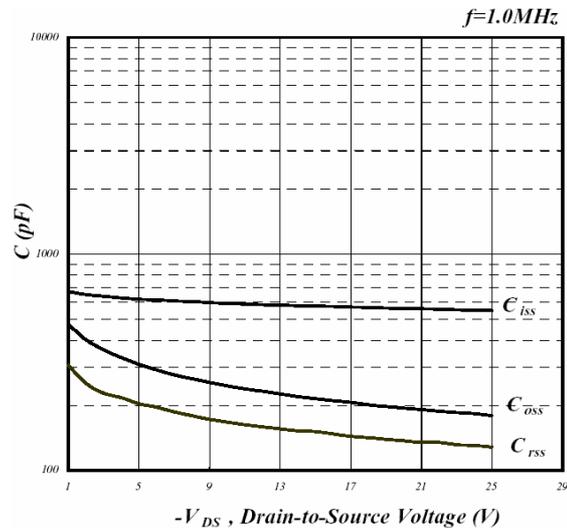
**Fig 5. Forward Characteristics of Reverse Diode**



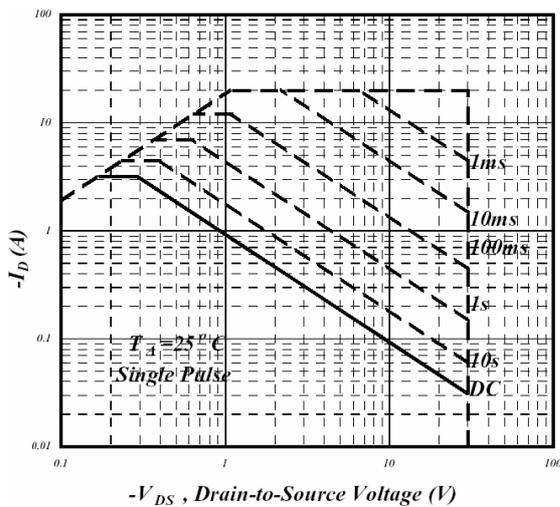
**Fig 6. Gate Threshold Voltage v.s. Junction Temperature**



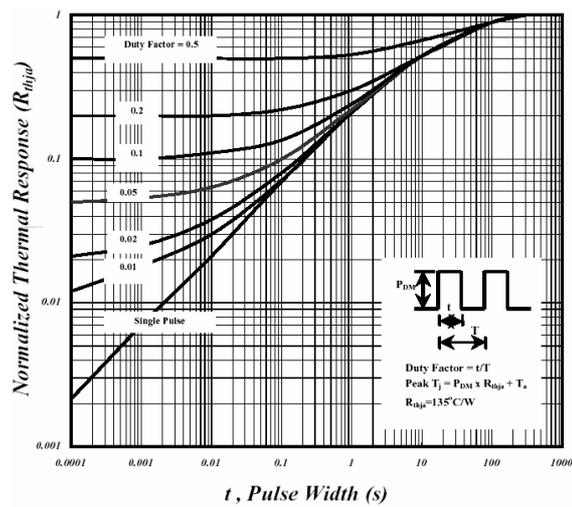
**Fig 7. Gate Charge Characteristics**



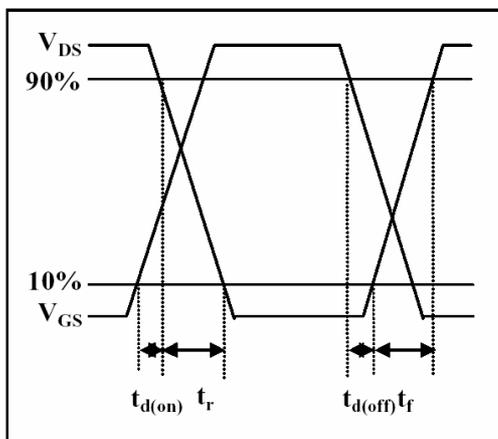
**Fig 8. Typical Capacitance Characteristics**



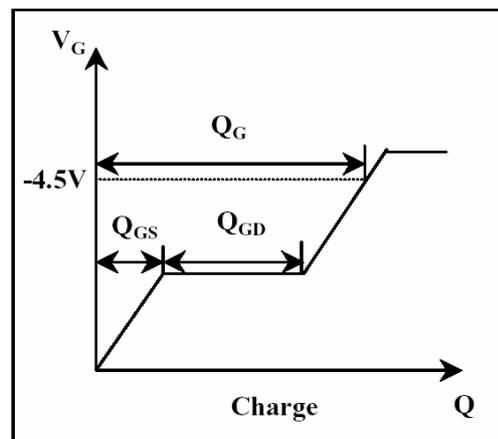
**Fig 9. Maximum Safe Operating Area**



**Fig 10. Effective Transient Thermal Impedance**



**Fig 11. Switching Time Waveform**



**Fig 12. Gate Charge Waveform**